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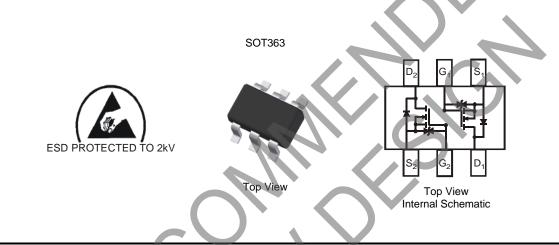
DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Features

- Dual N-Channel MOSFET
- Low On-Resistance (1.0V Max)
- Very Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- ESD Protected up to 2kV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.006 grams (Approximate)



Ordering Information (Note 4)

	Part Number			Case	Packaging
	DMN5L06DWK-7			SOT363	3,000/Tape & Reel
Notes:	1. No purposely added lead. Full	y EU Direc	tive 2002/95	/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



DAB = Marking Code YM = Date Code Marking Y = Year ex: G = 2019 M = Month ex: 9 = September

Year	2006	2007	2008		2012	2013	2014	2015	2016	2017	2018	2019
Code	Т	U	V		Z	А	В	С	D	E	F	G
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



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DMN5L06DWK

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Chai	racteristic	Symbol	Value	Unit
Drain Source Voltage		V _{DSS}	50	V
Gate-Source Voltage		V _{GSS}	±20	V
Drain Current	Continuous	1-	305	mA
	Pulsed (Note 6)	ID	800	ША

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	250	mW
Thermal Resistance, Junction to Ambient	R _{0JA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	50			V	$V_{GS} = 0V, I_D = 10\mu A$	
Zero Gate Voltage Drain Current @ T _C = +25°C				60	nA	$V_{DS} = 50V, V_{GS} = 0V$	
				1	μA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
Gate-Body Leakage	lgss	—		500	nA	$V_{GS} = \pm 10V, V_{DS} = 0V$	
				50	nA	$V_{GS} = \pm 5V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	0.49	_	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
		—		3.0		$V_{GS} = 1.8V, I_D = 50mA$	
Static Drain-Source On-Resistance	R _{DS(ON)}	—		2.5	Ω	$V_{GS} = 2.5V, I_D = 50mA$	
		-		2.0		$V_{GS} = 5.0V, I_D = 50mA$	
On-State Drain Current	D(ON)	0.5	1.4		A	$V_{GS} = 10V, V_{DS} = 7.5V$	
Forward Transconductance	Y _{FS}	200		_	mS	$V_{DS} = 10V, I_D = 0.2A$	
Source-Drain Diode Forward Voltage	Vsd	0.5		1.4	V	$V_{GS} = 0V, I_{S} = 115mA$	
DYNAMIC CHARACTERISTICS (Note 8)		-					
Input Capacitance	Ciss	—	—	50	pF		
Output Capacitance	Coss			25	pF	V _{DS} = 25V, V _{GS} = 0V f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}			5.0	pF	1 = 1.00012	
Gate Resistance	R _G	_	65		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	Q _G	—	0.4	_	nC		
Gate-Source Charge		_	0.1	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$	
Gate-Drain Charge	Q _{GD}	_	0.1	_	nC	I _D = 0.25A	
Turn-On Delay Time	t _{D(ON)}		2.1	_	ns		
Turn-On Rise Time	t _R		1.8		ns	$V_{DD} = 30V, V_{GS} = 10V,$	
Turn-Off Delay Time			14.4		ns	$R_{G} = 25\Omega, I_{D} = 0.2A$	
Turn-Off Fall Time	t _{D(OFF)}		8.4	_	ns		

 Notes:
 5. Device mounted on FR-4 PCB.

 6. Pulse width ≤10μS, Duty Cycle ≤1%.

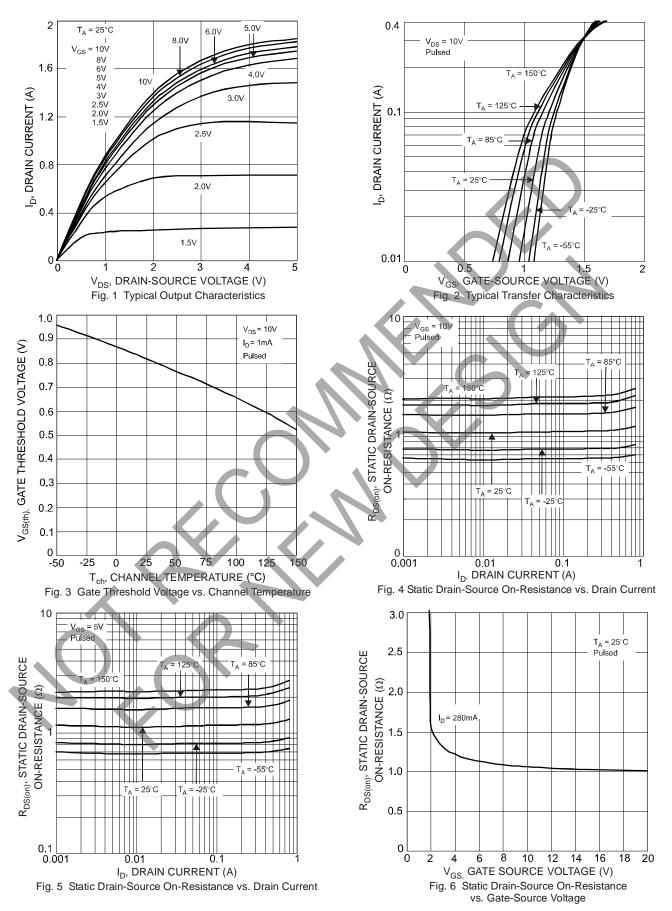
 7. Short duration pulse test used to minimize self-heating effect.

 8. Guaranteed by design. Not subject to product testing.



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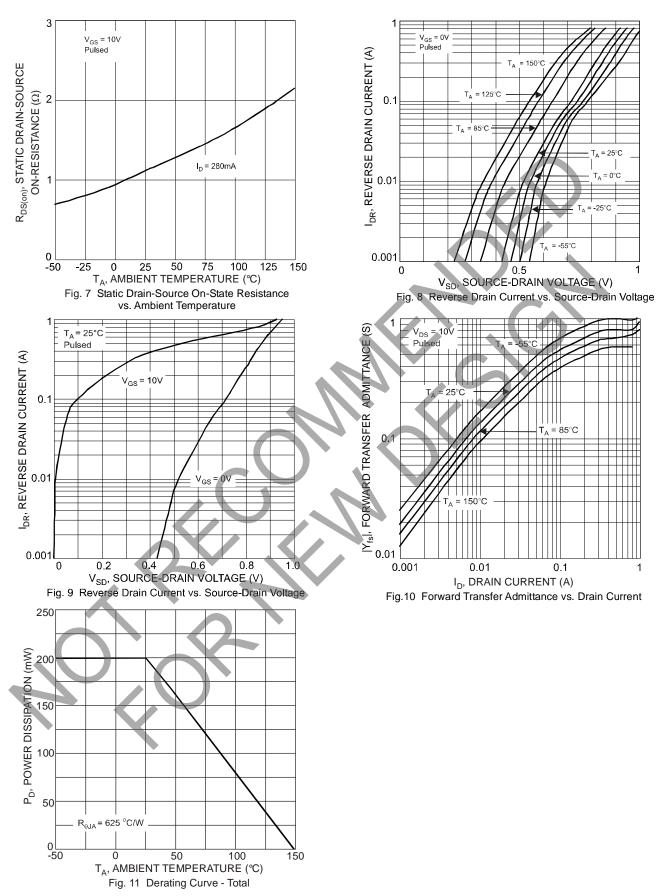
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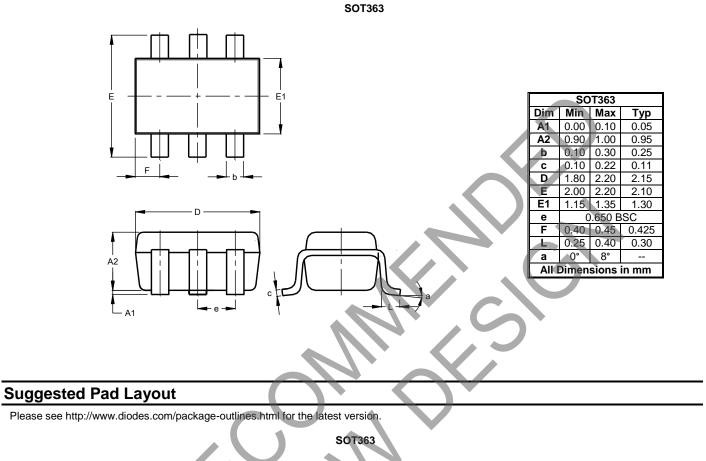
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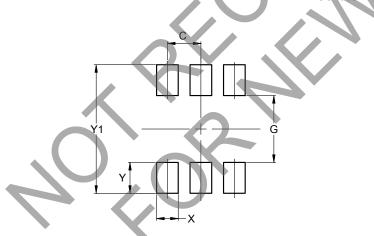




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value				
Dimensions	(in mm)				
С	0.650				
G	1.300				
Х	0.420				
Y	0.600				
Y1	2.500				



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